

P-Channel 100 V (D-S) MOSFET

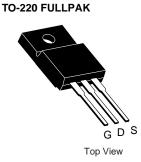
PRODUCT	SUMMARY		
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)
- 100	0.220 at V_{GS} = - 10 V	- 12	11.7
- 100	0.230 at V _{GS} = - 4.5 V	- 10	11.7

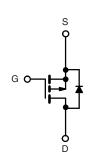
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET ٠
- 100 % R_g and UIS Tested
 Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Power Switch
- DC/DC Converters





P-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S T _C = 25 °C, unless othe	rwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 100	V	
Gate-Source Voltage		V _{GS}	± 20	v	
Continuous Drain Current (T ₁ = 150 °C)	T _C = 25 °C	1-	- 12	A	
Continuous Drain Current (1) = 150°C)	T _C = 70 °C	۱ _D	- 8.6		
Pulsed Drain Current		I _{DM}	- 36	A	
Avalanche Current		I _{AS}	- 18		
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	16.2	mJ	
	T _C = 25 °C	D	38.1 ^b	w	
Maximum Power Dissipation ^a	T _A = 25 °C ^c	– P _D	2.5		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Limit	Unit
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	50	°C/W
Junction-to-Case (Drain)	R _{thJC}	3.9	C/VV

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).

3MB2102M					YB www.V	VBse1 Bsemi.co
SPECIFICATIONS T _J = 25 °				True	Max	L lucit
Parameter Static	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V _{DS}	V _{DS} = 0 V, I _D = - 250 μA	- 100			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	- 1		- 2.5	v
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	•		± 250	nA
	000	$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$			- 50	μA
	500	$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 \text{ °C}$			- 250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	- 15			A
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 10 V, I _D = - 3.6 A		0.220		Ω
		V _{GS} = - 4.5 V, I _D = - 3.4 A		0.230		
Forward Transconductance ^a	g _{fs}	V _{DS} = - 15 V, I _D = - 3.6 A		12		S
Dynamic ^b						
Input Capacitance	C _{iss}			1055		
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = - 50 V, f = 1 MHz		65		pF
Reverse Transfer Capacitance	C _{rss}			41		
	0	$V_{DS} = -50 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3.6 \text{ A}$		23.2	34.8	
Total Gate Charge ^c	Qg			11.7	17.6	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = -50 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -3.6 \text{ A}$		3.5		nC
Gate-Drain Charge ^c	Q _{gd}] [4.8		
Gate Resistance	Rg	f = 1 MHz	1.2	5.7	11.5	Ω
Turn-On Delay Time ^c	t _{d(on)}			7	14	
Rise Time ^c	t _r	V_{DD} = - 50 V, R _L = 17.2 Ω I _D ≅ - 2.9 A, V _{GEN} = - 10 V, R _g = 1 Ω		12	18	- ns
Turn-Off Delay Time ^c	t _{d(off)}			33	50	
Fall Time ^c	t _f			9	18	
Drain-Source Body Diode Ratings ar	nd Character	istics T _C = 25 °C ^b				
Continuous Current	۱ _S				- 8.8	
Pulsed Current	I _{SM}				- 15	A
Forward Voltage ^a	V _{SD}	I _F = - 2.9 A, V _{GS} = 0 V		- 0.8	- 1.5	V
Reverse Recovery Time	t _{rr}			50	75	ns
Deals Baseres Baserers Oursest	1	L = 2.0.4 dl/dt = 100.4/wa		4	6	^

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

I_{RM(REC)} Q_{rr}

c. Independent of operating temperature.

Peak Reverse Recovery Current

Reverse Recovery Charge

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

 $I_F = -2.9 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$

- 4

98

- 6

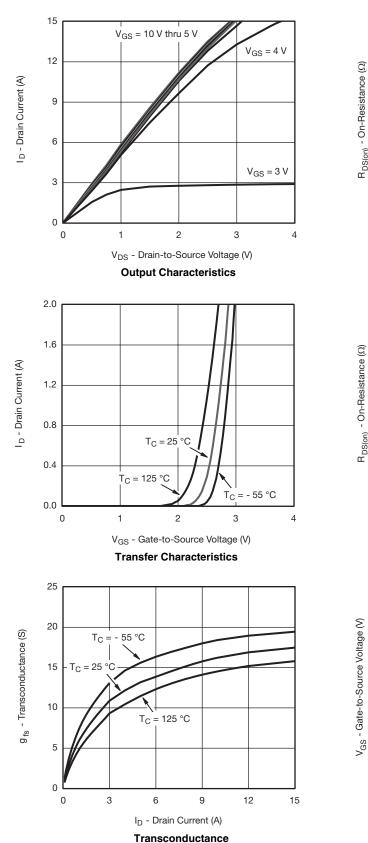
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А

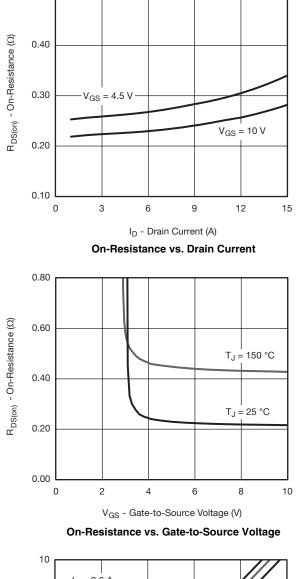
nC



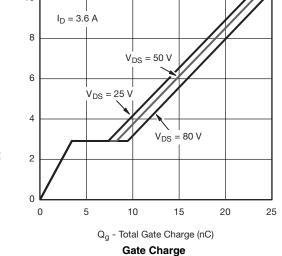




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

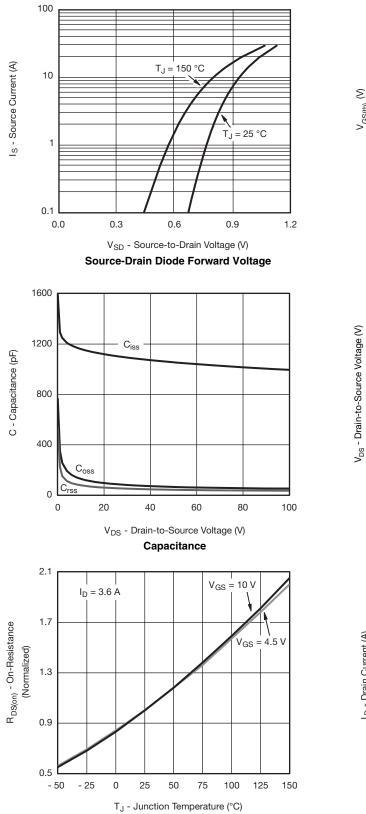


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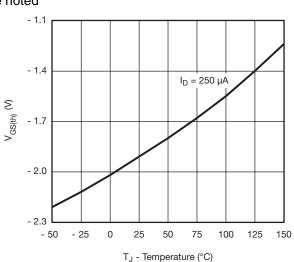




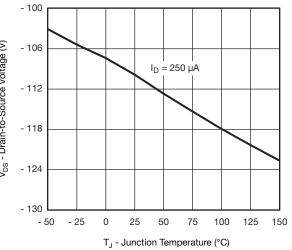
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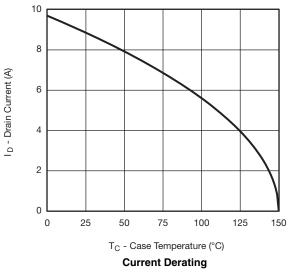
On-Resistance vs. Junction Temperature



Threshold Voltage



Drain Source Breakdown vs. Junction Temperature



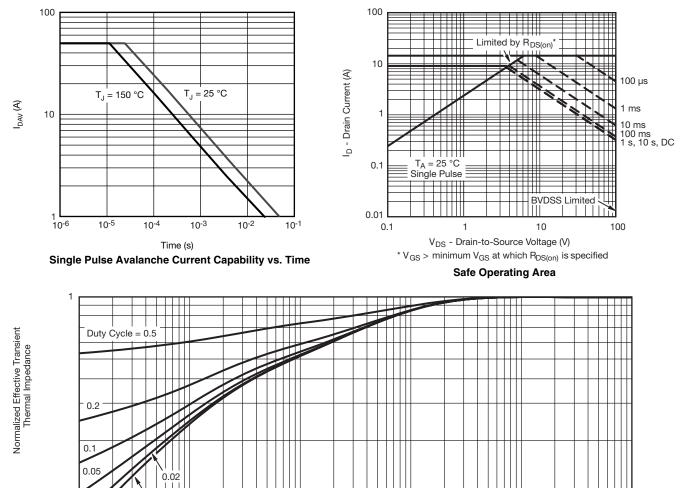


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Single Pulse

10⁻³

0.1 -4 10⁻⁴



Square Wave Pulse Duration (s)

10-2



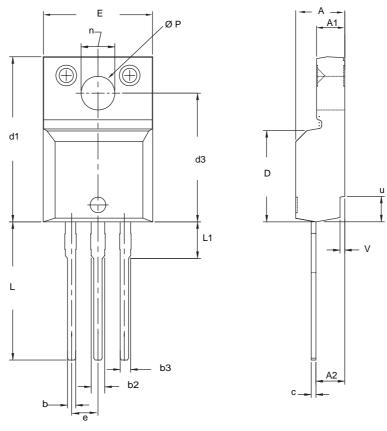
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TO-220 FULLPAK



	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
C	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	2.54 BSC		0.100 BSC	
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
Ø P	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

Notes

Notes 1. To be used only for process drawing. 2. These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads. 3. All critical dimensions should C meet $C_{pk} > 1.33$. 4. All dimensions include burrs and plating thickness. 5. No chipping or package damage.



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